

Features

- 1206 SMD LED
- Close responsively to the human eye spectrum
- Light to Current, analog output
- Good output linearity across wide illumination range
- Low sensitivity variation across various light sources

Applications

- Infrared application system
- Optoelectronic automatic control system
- Optoelectronic switch
- Printer
- Counters and sorters
- Encoders
- Floppy disk drive
- Video camera, tape and card readers
- Position sensors

Description

The IN-S126BTNPT is a popular 1206 package with versatile design capabilities. It is a PCB type LED which can be used in various applications. Due to its **black** epoxy, the device is matched to visible light and infrared radiation.

Recommended Solder Pattern

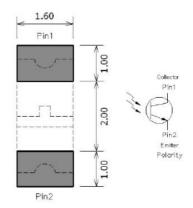
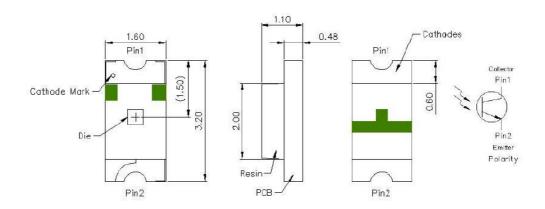


Figure 1. IN-S126BTNPT Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10 mm unless otherwise noted

Figure 2. IN-S126BTNPT Package Dimensions



Absolute Maximum Rating at 25°C

| Symbol | Parameters | Ratings | Units | Notes |
|--------|---|----------|-------|-------|
| BVCEO | Collector-Emitter Breakdown Voltage | 35 | V | 1 |
| BVECO | BVECO Emitter-Collector Breakdown Voltage | | V | 2 |
| lc | Collector Current | 20 | mA | |
| Topr | Operating Temperature | -40~+85 | °C | |
| Tstg | Storage Temperature | -40~+100 | °C | |
| Tsol | Tsol Soldering Temperature | | °C | 3 |
| Pto | Pto Total Power Dissipation | | mW | |

Notes

- 1. Test conditions: Ic=100µA, Ee=0mW/cm2.
- 2. Test conditions: IE=100 μ A, Ee=0mW/cm₂.
- 3. Soldering time \leq 5 seconds.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

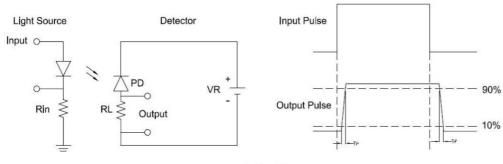


Electro-Optical Characteristics

| Symbol | Parameters | Test conditions | Min | Тур | Max | Units | Notes |
|----------|---|--|-----|-----|------|-------|-------|
| λD | Rang Of Spectral Bandwidth | | 750 | - | 1100 | nm | |
| λP | Wavelength Of Peak Sensitivity | | - | 940 | | nm | |
| BVCEO | Collector-Emitter Breakdown Voltage | Ic=100µA _{Ee} =0mW/cm² | - | 30 | - | V | |
| BVECO | Emitter-Collector Breakdown Voltage | I∈=100µA Ee=0mW/cm² | - | 5 | - | V | |
| VCE(sat) | Collector-Emitter Saturation Voltage | Ic=2mA Ee=1mW/cm ² | - | - | 0.4 | V | |
| ICEO | Collector Dark Current | VCE=20V Ee=0mW/cm ² | - | - | 100 | nA | |
| IC(ON) | On State Collector Current | Ee=1mW/cm ² λ _P =940nm, Vcε=5V | 0.1 | 0.5 | 0.8 | mA | |
| tr | Rise Time | Vce=5V, Ic=1mA | - | 15 | - | uS | 4 |
| tr | Fall Time | RL=1000Ω | - | 15 | - | uS | 4 |

Notes

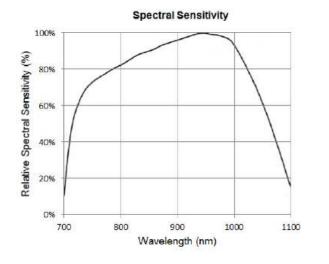
4. Test circuit :

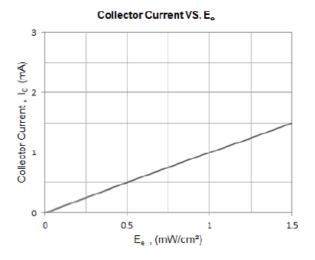


Switching Time

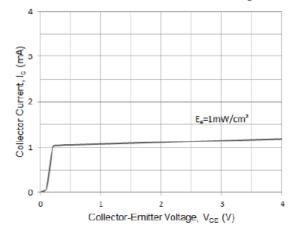


Typical Characteristic Curves





Collector Current VS. Collector-Emitter Voltage

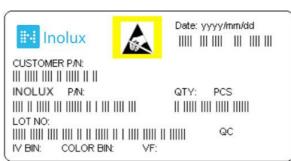




Ordering Information

| Product | Symbol | Parameters | Test conditions | Min | Тур | Max | Units | Orderable Part Number |
|--------------|--------|----------------------------|---|-----|-----|-----|-------|--------------------------|
| IN-S126BTNPT | IC(ON) | On State Collector Current | Ee=1mW/cm ² λ _P =940nm, V _{CE} =5V | 0.1 | 0.5 | 0.8 | mA | IN-S126BTNPT |

Label Specifications



Inolux P/N:

| Ι | Ν | - | S | 126 | В | Т | Ν | РТ | - | - | - | - | - |
|---|-------------|---|----------|----------------------|-----------|---------------|-----------|--------------------------|---|---|---------------|---|---|
| | | | Material | Package | Variation | Orientation | Lens | Color | | | ıstor tamı | | |
| | olux ⁄ID | | PCB - S | 126B = 120 molder | | T = Top Mount | N = Black | PT = Photo Transistor | | | | | |

Lot No.:

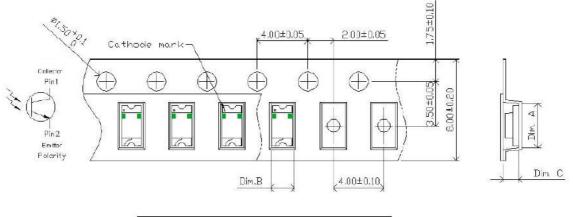
| Z | 2 | 0 | 1 | 7 | 01 | 24 | 001 |
|---------------------|--------------------|---|---|---|-------|------|--------|
| Internal Tracker | Year (2017, 2018,) | | | | Month | Date | Serial |



Packaging Information:

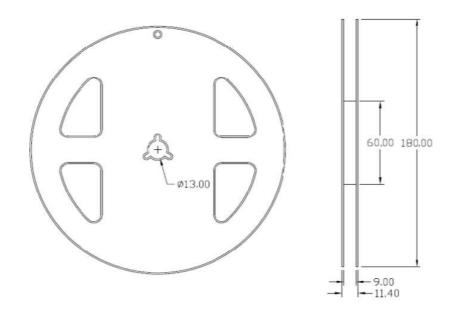
Packaging

Tape Dimension



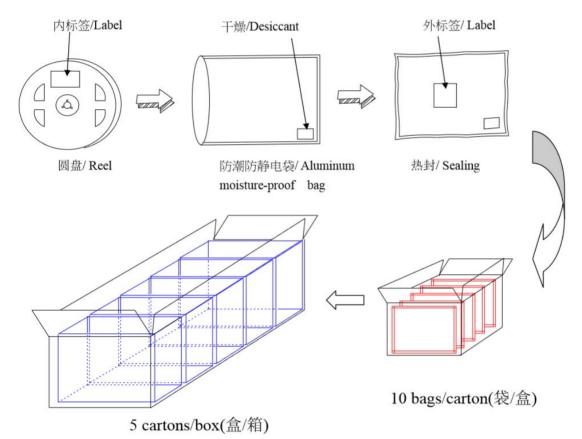
| Dim. A | Dim. B | Dim. C | Q'ty/Reel |
|-----------|-----------|-----------|-----------|
| 3.50±0.05 | 1.88±0.05 | 1.27±0.05 | ЗK |

Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

| | Specification | Material | Quantity |
|--------------|----------------------|---|------------------|
| Carrier tape | Per EIA 481-1A specs | Conductive black tape | 3000pcs per reel |
| Reel | Per EIA 481-1A specs | Conductive black | |
| Label | IN standard | Paper | |
| Packing bag | 220x240mm | Aluminum laminated bag/ no-zipper | One reel per bag |
| Carton | IN standard | Paper | Non-specified |
| Others: | | | |
| | | reels may not necessarily have the same lot cation; the immediate box consists of a produ | |

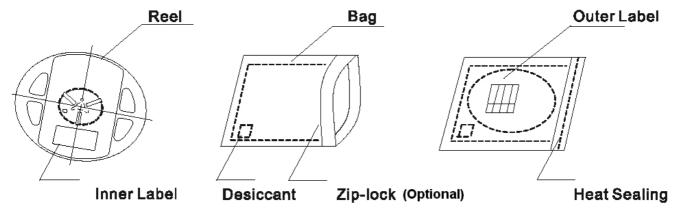


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Pre-heating 180-200°C 120sec. Max. 4°C/sec. Max. 60sec. Max. Above 220°C 120sec. Max.

Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

| Item | Frequency/ lots/ samples/ | Standards | Conditions |
|---------------------|----------------------------|-----------------|--|
| | failures | Reference | |
| | For all reliability | J-STD-020 | 1.) Baking at 85°C for 24hrs |
| Precondition | monitoring tests according | | 2.) Moisture storage at 85°C/ 60% R.H. for |
| | to JEDEC Level 2 | | 168hrs |
| | 1Q/ 1/ 22/ 0 | JESD22-B102-B | Accelerated aging 155°C/ 24hrs |
| Solderability | | And CNS-5068 | Tinning speed: 2.5+0.5cm/s |
| | | | Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s |
| | | CNS-5067 | Dipping soldering terminal only |
| Resistance to | | | Soldering bath temperature |
| soldering heat | | | A: 260+/-5°C; 10+/-1s |
| | | | B: 350+/-10°C; 3+/-0.5s |
| | 1Q/ 1/ 40/ 0 | CNS-11829 | 1.) Precondition: 85°C baking for 24hrs |
| Operating life test | | | 85°C/ 60%R.H. for 168hrs |
| | | | 2.) Tamb25°C; IF=20mA; duration 1000hrs |
| High humidity, | 1Q/ 1/ 45/ 0 | JESD-A101-B | Tamb: 85°C |
| high temperature | | | Humidity: 85% R.H., IF=5mA |
| bias | | | Duration: 1000hrs |
| High temperature | 1Q/ 1/ 20 | IN specs. | Tamb: 55°C |
| bias | | | IF=20mA |
| DIAS | | | Duration: 1000hrs |
| | 1Q/ 1/ 40/ 0 | | Tamb25°C, If=20mA,, Ip=100mA, Duty |
| Pulse life test | | | cycle=0.125 (tp=125 μ s,T=1sec) |
| | | | Duration 500hrs) |
| | 1Q/ 1/ 76/ 0 | JESD-A104-A | A cycle: -40 degree C 15min; +85 degree C |
| Tamparatura | | IEC 68-2-14, Nb | 15min |
| Temperature | | | Thermal steady within 5 min |
| cycle | | | 300 cycles |
| | | | 2 chamber/ Air-to-air type |
| High humidity | 1Q/ 1/ 40/ 0 | CNS-6117 | 60+3°C |
| storage test | | | 90+5/-10% R.H. for 500hrs |
| High temperature | 1Q/ 1/ 40/ 0 | CNS-554 | 100+10°C for 500hrs |
| storage test | | | |
| Low temperature | 1Q/ 1/ 40/ 0 | CNS-6118 | -40+5°C for 500hrs |
| storage test | | | |



Revision History

| Changes since last revision | Page | Version No. | Revision Date |
|-----------------------------|------|-------------|----------------------|
| Initial Release | | 1.0 | 01-31-2019 |
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